

BAT760HS

SCHOTTKY BARRIER DIODE

Features

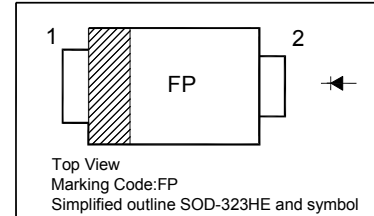
- Ultra high-speed switching
- Very low forward voltage
- Very small SMD plastic package

Applications

- Ultra high-speed switching
- Voltage clamping
- Protection circuits

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Reverse Voltage	V_R	20	V
Continuous Forward Current	I_F	1	A
Non-repetitive Peak Forward Current (t = 8.3 ms Half Sine Wave, JEDEC method)	I_{FSM}	25	A
Junction Temperature	T_J	125	$^\circ\text{C}$
Operating Ambient Temperature Range	T_{op}	- 65 to + 125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 150	$^\circ\text{C}$
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	220 ¹⁾ 180 ²⁾	K/W

¹⁾ Mounted on P.C.B. 10 X 10 mm² Cu

²⁾ Mounted on P.C.B. 40 X 40 mm² Cu

Characteristics at $T_a = 25^\circ\text{C}$

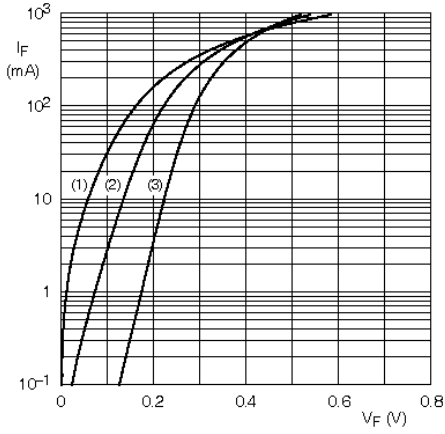
Parameter	Symbol	Typ.	Max.	Unit
Forward Voltage at $I_F = 10\text{ mA}$ at $I_F = 100\text{ mA}$ at $I_F = 1\text{ A}$	V_F	- - -	0.27 0.35 0.65	V
Reverse Current at $V_R = 5\text{ V}$ at $V_R = 8\text{ V}$ at $V_R = 15\text{ V}$	I_R	- - -	10 20 50	μA
Diode Capacitance at $V_R = 5\text{ V}$, $f = 1\text{ MHz}$	C_d	25	-	pF

TOP DYNAMIC



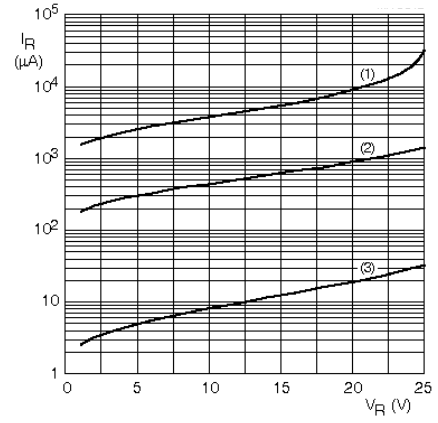
Dated:09/07/2015 Rev: 03

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- (1) $T_{amb} = 85\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -40\text{ }^{\circ}\text{C}$.

Forward current as a function of forward voltage; typical values.



- (1) $T_{amb} = 125\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 85\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = 25\text{ }^{\circ}\text{C}$.

Reverse current as a function of reverse voltage; typical values.

TOP DYNAMIC



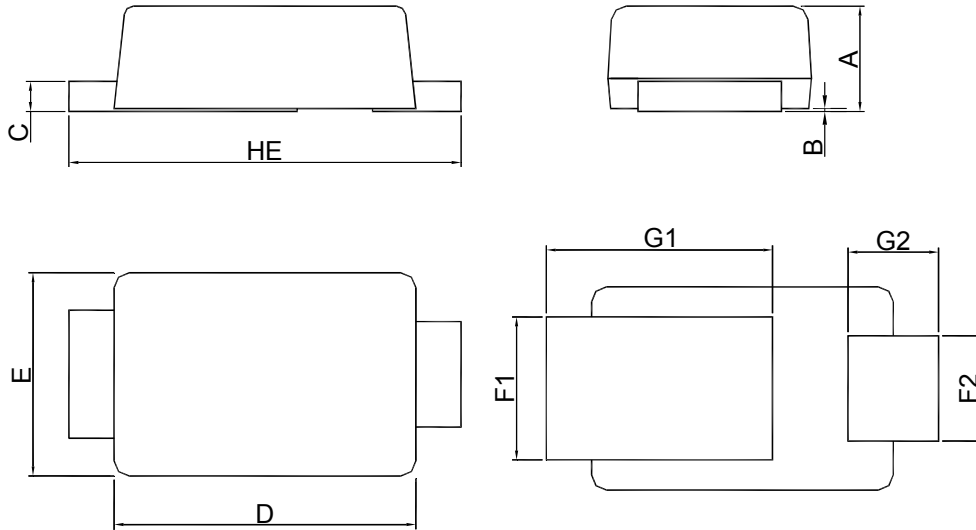
ISO14001 : 2004 Certificate No. 121505007 ISO 9001 : 2008 Certificate No. 02114012 OHSAS 18001 : 2007 Certificate No. 05191508008 IECQ QC 080000 Certificate No. E24180007 H4M2

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PACKAGE OUTLINE

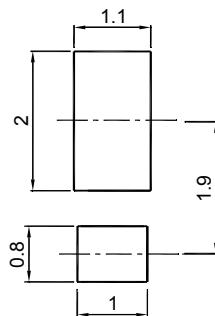
Plastic surface mounted package; 2 leads

SOD-323HE



UNIT	A	B	C	D	E	F1	F2	G1	G2	H _E
mm	0.7	0.02	0.2	2	1.35	0.95	0.7	1.5	0.6	2.6
	0.5	0	0.1	1.8	1.15	0.75	0.5	1.3	0.4	2.4

RECOMMENDED SOLDERING FOOTPRINT



SOD-323HE

Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323HE	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

TOP DYNAMIC

